TOSHIBA Photocoupler Photorelay

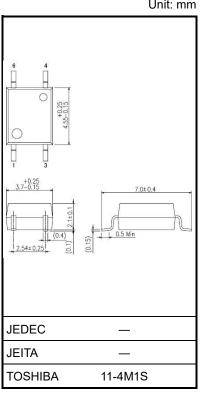
TLX9175J

Battery Control in Automotive Equipment Fuel Battery Control in Automotive Equipment **Application for Electrical Vehicle**

The Toshiba TLX9175J consists of an infrared LED optically coupled to a photo-MOSFET in a SO6 package.

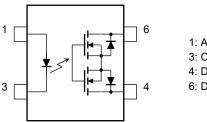
This coupler use high voltage MOSFET between output terminals. It adequate for the applications of Battery Control Systems.

- Normally open (1-Form-A) device
- Peak off-state voltage: 600 V (min)
- Trigger LED current: 3 mA (max) •
- On-state current: 15 mA (max) •
- On-state resistance: $335 \Omega (max)(@t < 1 s)$
- Isolation voltage: 3750 Vrms (min) •
- AEC-Q101 qualified



Weight: 0.08 g (typ.)

Pin Configuration (top view)



1: Anode 3: Cathode 4: Drain 6: Drain

Unit: mm

	Characteristics	Symbol	Rating	Unit	
- 50	Forward current	lF	25	mA	
	Forward current derating (Ta ≥ 70	∆IF/°C	-0.18	mA/°C	
	Reverse voltage	VR	5	V	
LED	Input Power Dissipation		PD	50	mW
	Input Power Dissipation Derating (Ta ≥ 70 °C)	∆PD/°C	-0.61	mW/°C
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage		Voff	600	V
		Ta = 25 °C		15	mA
	On-state current	Ta = 85 °C	Ion	11	mA
		Ta = 105 °C		7	mA
		Ta ≥ 60 °C	∆l _{ON} /°C	-0.16	
_	Forward current derating	Ta ≥ 85 °C		-0.2	mA/°C
Detector	On-state current (Peak) (Note 2)	Ta = 25 °C		80	mA
		Ta = 85 °C	lONpk	50	mA
	(*)	Ta = 105 °C		25	mA
	Output power dissipation	Po	90	mW	
	Output power dissipation derating	∆Po/°C	-0.9	mW/°C	
	Junction temperature	Tj	125	°C	
Storage te	Storage temperature			-55 to 125	°C
Operating	Operating temperature			-55 to 105	°C
Lead solde	Lead soldering temperature (10 s)			260	°C
Isolation v	lsolation voltage (AC, 60 s, R.H. ≤ 60%) (Note 1)			3750	Vrms

Absolute Maximum Rating (Unless otherwise specified, Ta = 25°C) (Note)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This product is more sensitive than conventional products to electrostatic discharge (ESD). It is therefore all the more necessary to observe general precautions regarding ESD when handling this component.

Note 1: LED pins are shorted together. Detector pins are also shorted together.

Note 2: Exponential curve, pulse width < 1ms, f ≤150Hz

Recommended Operating Conditions (Note)

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	_	_	450	V
Forward current	lF	10	12	20	mA
On-state current	ION	_	_	10	mA
Operating temperature	Topr	-40	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
	Forward voltage	VF	I _F = 10 mA	1.5	1.65	1.8	V	
LED			IF = 10 mA , Ta = -40 to 105 °C	1.4	_	1.95	V	
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA	
	Capacitance	CT	V = 0 V, f = 1 MHz		45		pF	
Detector	Off-state current	IOFF	Voff = 600 V , Ta = 25 °C		10	50		
			Voff = 600 V , Ta = 85 °C		—	250	nA	
			Voff = 600 V , Ta = 105 °C		—	400		
	Capacitance	COFF	V _{OFF} = 0 V, f = 1 MHz		8.0	_	pF	

Coupled Electrical Characteristics

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
		I _{ON} = 15 mA , Ta=25 °C , t = 10 ms			3	
Trigger LED current	IFT	I _{ON} = 11 mA , Ta= -40 to 85 °C, t = 10 ms	_	_	5	mA
		I _{ON} = 7 mA, Ta= -40 to 105 °C, t = 10 ms	_	_	8	
		IOFF = 100 μA, Ta= 25 °C, t = 40 ms	0.1	_	_	mA
Return LED current	IFC	IOFF = 100 μA, Ta= -40 to 85 °C, t = 40 ms	0.05	_	_	
		IOFF = 100 μA, Ta= -40 to 105 °C, t = 40 ms	0.05	_	_	
	Ta = 25 I _{ON} = 1 Ta = 85	I _{ON} = 15 mA, IF = 10 mA, Ta = 25 °C, t < 1 s		_	335	
		I _{ON} = 11 mA, I _F = 10 mA, Ta = 85 °C, t < 1 s	310	310 — 510		Ω
On-state resistance	Ron	I _{ON} = 7 mA, IF = 10 mA, Ta = 105 °C, t <1 s		_	650	
		I _{ON} = 15 mA, I _F = 10 mA, Ta = 25 °C, t > 60 s		360		

Isolation Characteristics (Ta = 25°C)

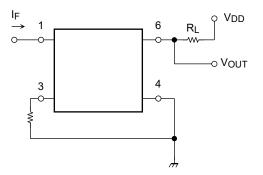
Characteristics Symbol		Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	$V_S = 0 V$, f = 1 MHz		0.5	_	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60 %	$5 imes 10^{10}$	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	3750	_	_	Vrms

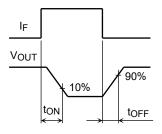
Note : Device considered a two terminal device: Pins 1 and 3 shorted together, and pins 4 and 6 shorted together.

Switching Characteristics

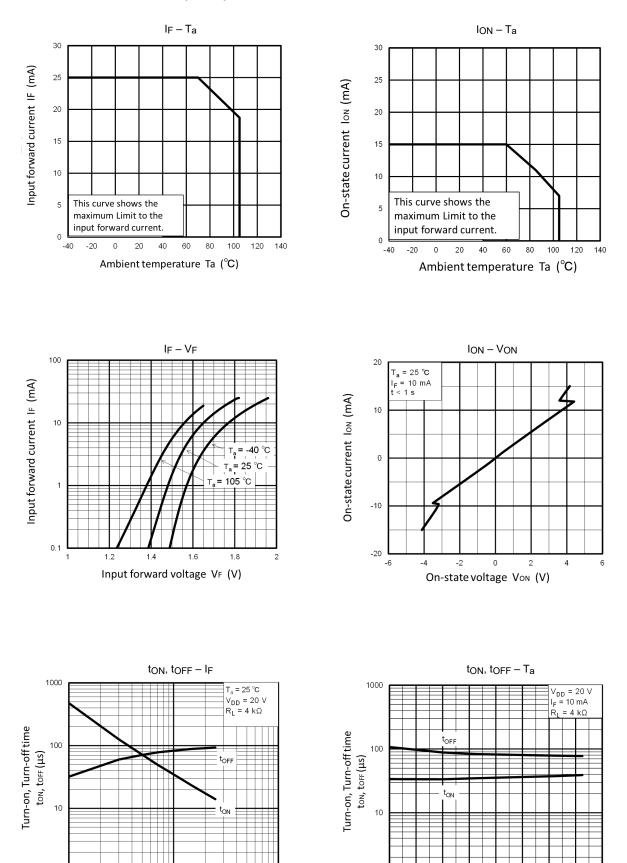
Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton	I _F = 10 mA,	Ta=25 °C	_	_	0.2	ms
Turn-off time	tOFF	$R_{L} = 4 k\Omega,$ $V_{DD} = 20 V$ (Note 1) $Ta=-40 to$ $105 °C$			_	0.2	
Turn-on time	ton		_	_	0.35		
Turn-off time	tOFF		105 °C	_	_	0.35	ms

Note 1: Switching time test circuit





Characteristic Curves (Note)



10

Input forward current IF (mA)

1

1

100

1

-40

-20

0 20

40

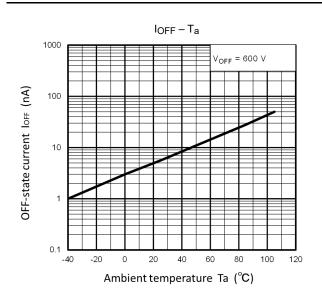
Ambient temperature Ta (°C)

60

120

100

80



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise specified.

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